

Provisional Data

Extra Fast Recovery Diode

Type F0300WC180

Old Type No.: F0258WC180

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V_{RRM}	Repetitive peak reverse voltage, (note 1)	1800	V
V_{RSM}	Non-repetitive peak reverse voltage, (note 1)	1900	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
$I_{F(AV)M}$	Maximum average forward current, $T_{sink}=55^{\circ}C$, (note 2)	240	A
$I_{F(AV)M}$	Maximum average forward current, $T_{sink}=85^{\circ}C$, (note 2)	160	A
$I_{F(AV)M}$	Maximum average forward, $T_{sink}=85^{\circ}C$, (note 3)	93	A
$I_{F(RMS)}$	Nominal RMS forward current, $T_{sink}=25^{\circ}C$, (note 2)	481	A
$I_{f(d.c.)}$	D.C. forward current, $T_{sink}=25^{\circ}C$, (note 4)	399	A
I_{FSM}	Peak non-repetitive surge $t_p=10ms$, $V_{RM}=60\%V_{RRM}$, (note 5)	2700	A
I_{FSM2}	Peak non-repetitive surge $t_p=10ms$, $V_{RM}\leq 10V$, (note 5)	3000	A
I^2t	I^2t capacity for fusing $t_p=10ms$, $V_{RM}=60\%V_{RRM}$, (note 5)	36.5×10^3	A^2s
I^2t	I^2t capacity for fusing $t_p=10ms$, $V_{RM}\leq 10V$, (note 5)	45.0×10^3	A^2s
$T_{j op}$	Operating temperature range	-40 to +125	$^{\circ}C$
T_{stg}	Storage temperature range	-40 to +150	$^{\circ}C$

Notes:-

- 1) De-rating factor of 0.13% per $^{\circ}C$ is applicable for T_j below $25^{\circ}C$.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, $125^{\circ}C$ T_j initial.
- 6) Current (I_F) ratings have been calculated using V_{T0} and r_T (see page 2).

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V_{FM}	Maximum peak forward voltage	-	-	2.45 3.1	$I_{FM}=300A$ $I_{FM}=600A$	V
V_{T0}	Threshold voltage	-	-	1.76	Current range 240A-720A (Note 2)	V
r_T	Slope resistance	-	-	2.21		mΩ
V_{T01}	Threshold voltage	-	-	1.841	Current range 300A-900A	V
r_{T1}	Slope resistance	-	-	2.044		mΩ
V_{FRM}	Maximum forward recovery voltage	-	-	40 80	$di/dt = 1000A/\mu s$ $di/dt = 1000A/\mu s, T_j=25^\circ C$	V
I_{RRM}	Peak reverse current	-	-	100 100	Rated V_{RRM} Rated $V_{RRM}, T_j=25^\circ C$	mA
Q_{ra}	Recovered charge, 50% Chord	-	75	-	$I_{FM}=300A, t_p=500\mu s, di/dt=2000A/\mu s,$ $V_r=400V, 50\% \text{ Chord. (note 3)}$	μC
t_{rr}	Reverse recovery time, 50% Chord	-	0.3	-		μs
I_{rm}	Reverse recovery current	-	530	-		A
Q_{ra}	Recovered charge, 50% Chord	-	5	8	$I_{FM}=550A, t_p=500\mu s, di/dt=40A/\mu s, V_r=50V,$ 50% Chord.	μC
t_{rr}	Reverse recovery time, 50% Chord	-	15	-		μs
I_{rm}	Reverse recovery current	-	0.7	-		A
R_{thJK}	Thermal resistance, junction to heatsink	-	-	0.095 0.19	Double side cooled Single side cooled	K/W
F	Mounting force	3.3	-	5.5		kN
W_t	Weight	-	70	-		g

Notes:-

- 1) Unless otherwise indicated $T_j=125^\circ C$.
- 2) V_{T0} and r_T were used to calculate the current ratings illustrated on page one.
- 3) Figures 3-7 were compiled using these conditions.
- 4) For other clamp forces consult factory.

Notes on Ratings and Characteristics

1.0 Voltage Grade Table

Voltage Grade	V _{RRM} (V)	V _{RSM} (V)	V _{RC} (V)
1800	1800	1900	1150

2.0 De-rating Factor

A blocking voltage de-rating factor of 0.13% per °C is applicable to this device for T_j below 25°C.

3.0 ABCD Constants

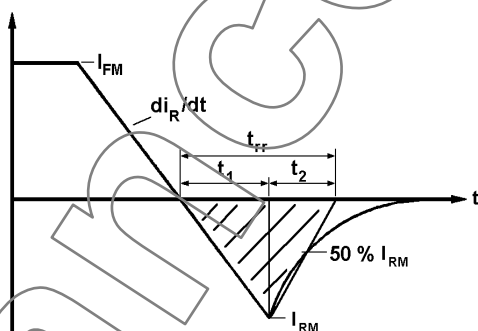
These constants (applicable only over current range of V_F characteristic in Figure 1) are the coefficients of the expression for the forward characteristic given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

where I_F = instantaneous forward current.

4.0 Reverse recovery ratings

(i) Q_{ra} is based on 50% I_{rm} chord as shown in Fig.(a) below.



(ii) Q_{rr} is based on a 150µs integration time.

i.e.
$$Q_{rr} = \int_0^{150\mu s} i_{rr} \cdot dt$$

(iii)
$$K \text{ Factor} = \frac{t_1}{t_2}$$

5.0 Reverse Recovery Loss

The following procedure is recommended for use where it is necessary to include reverse recovery loss.

From waveforms of recovery current obtained from a high frequency shunt (see Note 1) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be E joules per pulse. A new sink temperature can then be evaluated from:

$$T_{SINK} = T_{J(MAX)} - E \cdot [k + f \cdot R_{th(JK)}]$$

Where $k = 0.2314$ (°C/W)/s

E = Area under reverse loss waveform per pulse in joules (W.s.)

f = Rated frequency in Hz at the original sink temperature.

$R_{th(J-Hs)}$ = d.c. thermal resistance (°C/W)

The total dissipation is now given by:

$$W_{(tot)} = W_{(original)} + E \cdot f$$

NOTE 1 - Reverse Recovery Loss by Measurement

This device has a low reverse recovered charge and peak reverse recovery current. When measuring the charge, care must be taken to ensure that:

(a) AC coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.

(b) A suitable, polarised, clipping circuit must be connected to the input of the measuring oscilloscope to avoid overloading the internal amplifiers by the relatively high amplitude forward current signal.

(c) Measurement of reverse recovery waveform should be carried out with an appropriate critically damped snubber, connected across diode anode to cathode. The formula used for the calculation of this snubber is shown below:

$$R^2 = 4 \cdot \frac{V_r}{C_s \cdot di/dt}$$

Where: V_r = Commutating source voltage

C_s = Snubber capacitance

R = Snubber resistance

6.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

7.0 Computer Modelling Parameters

7.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_o + \sqrt{V_o^2 + 4 \cdot ff^2 \cdot r_s \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_s}$$

Where $V_{T0} = 1.76 \text{ V}$, $r_T = 2.21 \text{ m}\Omega$

ff = form factor (normally unity for fast diode applications)

$$W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j(MAX)} - T_K$$

7.2 Calculation of V_F using ABCD Coefficients

The forward characteristic I_F Vs V_F , on page 6 is represented in two ways;

- (i) the well established V_o and r_s tangent used for rating purposes and
- (ii) a set of constants A, B, C, and D forming the coefficients of the representative equation for V_F in terms of I_F given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given in this report for hot characteristics. The resulting values for V_F agree with the true device characteristic over a current range, which is limited to that plotted.

	25°C Coefficients	125°C Coefficients
A	0.68046964	0.047647534
B	0.3056439	0.3385448
C	1.26819×10^{-3}	1.331047×10^{-3}
D	-6.91545×10^{-3}	4.400832×10^{-3}

8.0 Frequency Ratings

The curves illustrated in figures 8 to 16 are for guidance only and are superseded by the maximum ratings shown on page 1.

9.0 Square wave ratings

These ratings are given for load component rate of rise of forward current of 100 and 500 A/ μ s.

10.0 Duty cycle lines

The 100% duty cycle is represented on all the ratings by a straight line. Other duties can be included as parallel to the first.

Curves

Figure 1 – Forward characteristics of Limit device

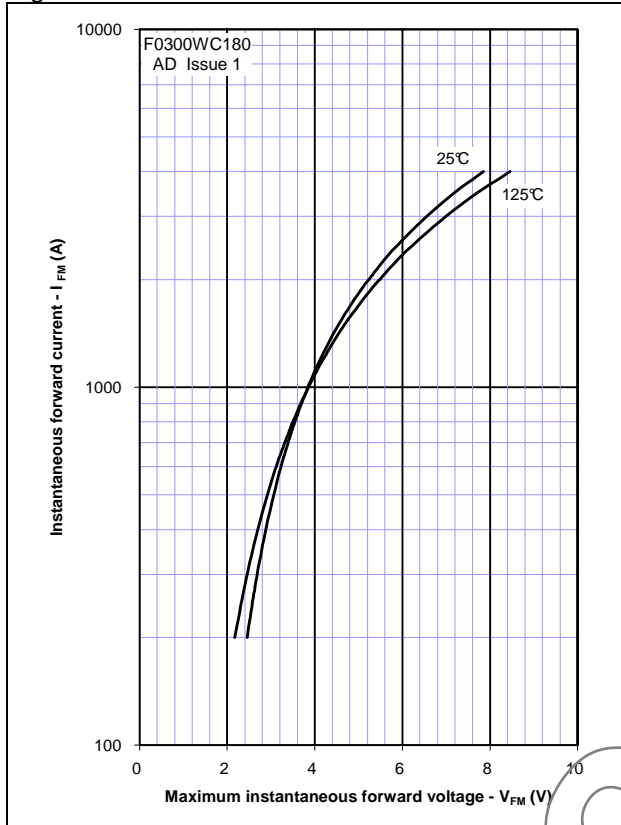


Figure 2 – Maximum forward recovery voltage

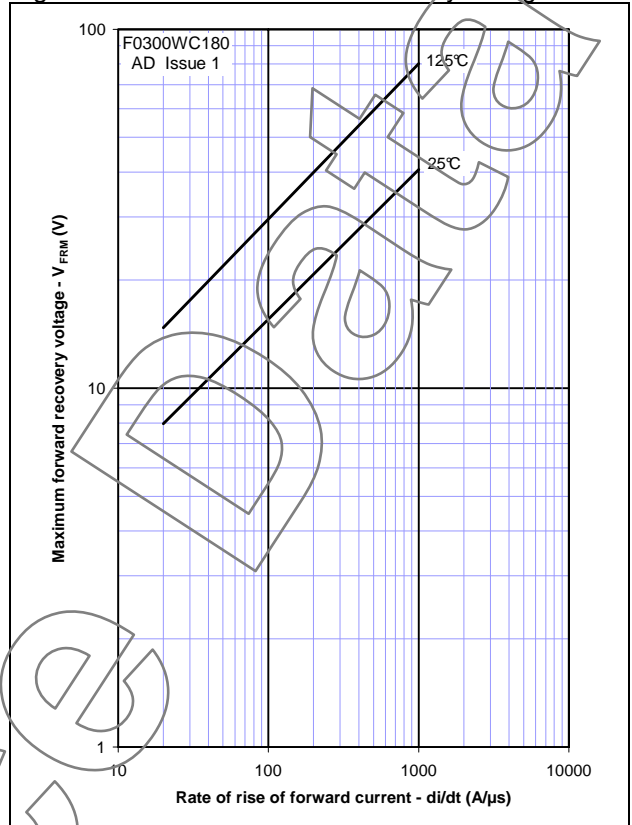


Figure 3 - Recovered charge, Q_{rr}

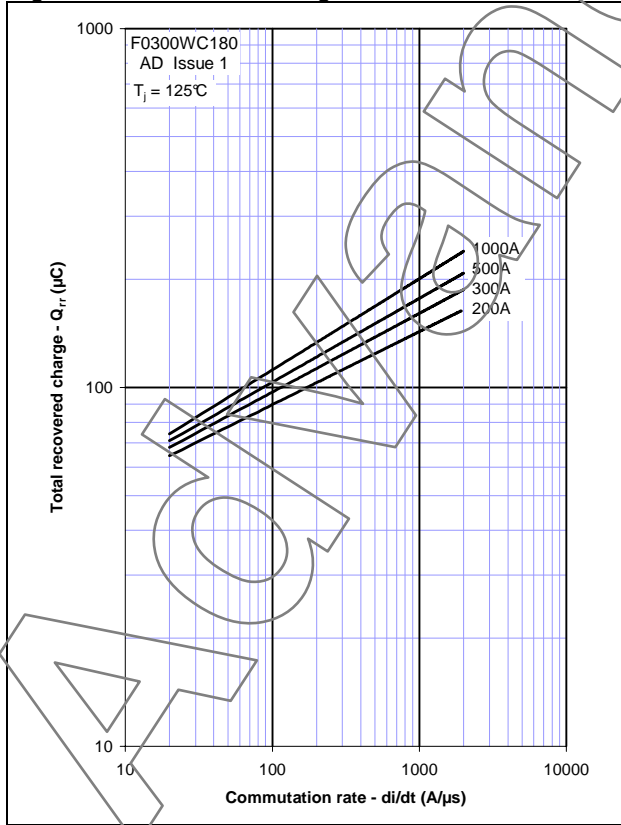


Figure 4 – Recovered charge, Q_{ra} (50% chord)

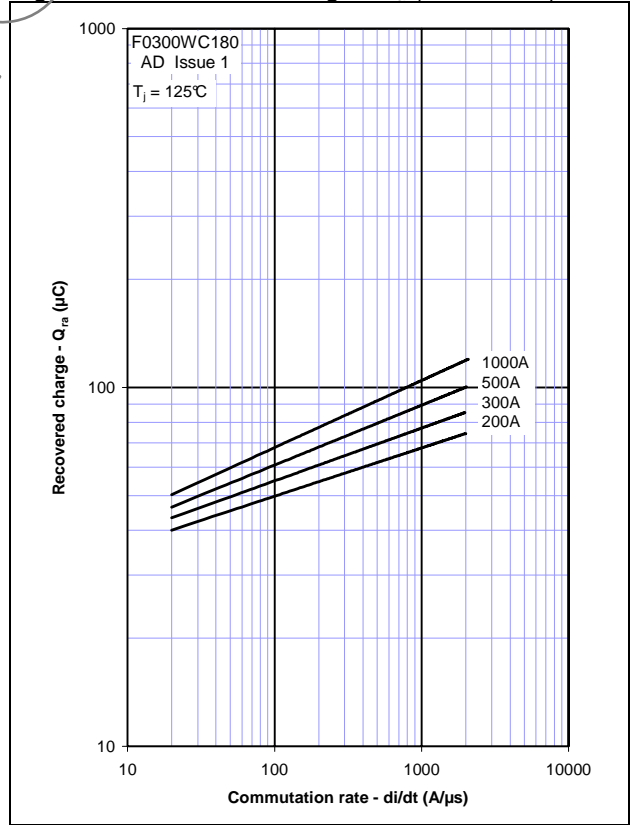


Figure 5 - Maximum reverse current, I_{rm}

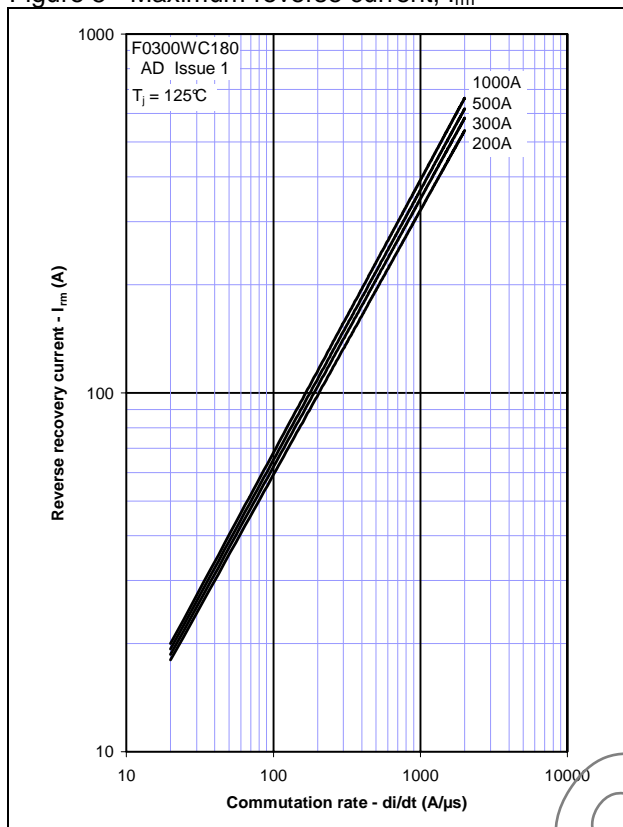


Figure 6 - Maximum recovery time, t_{rr} (50% chord)

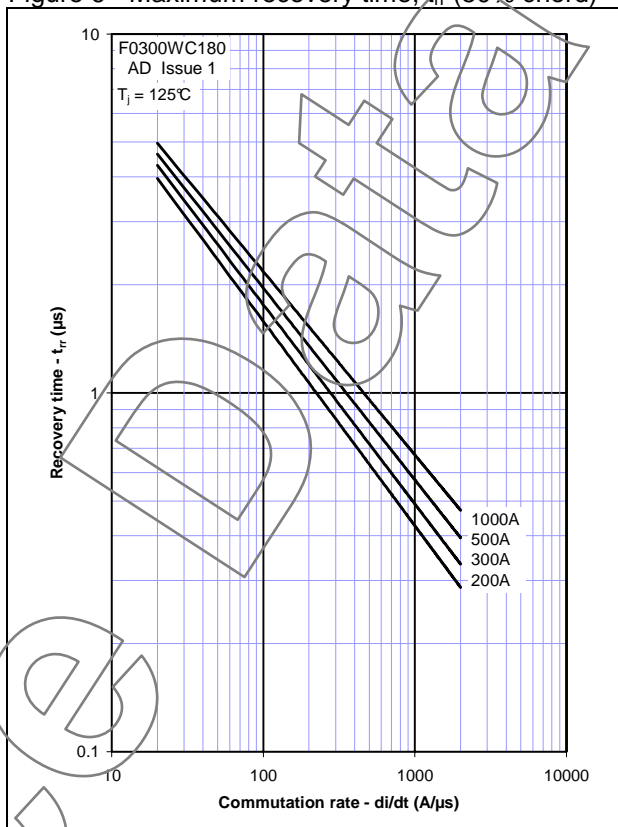


Figure 7 - Reverse recovery energy per pulse

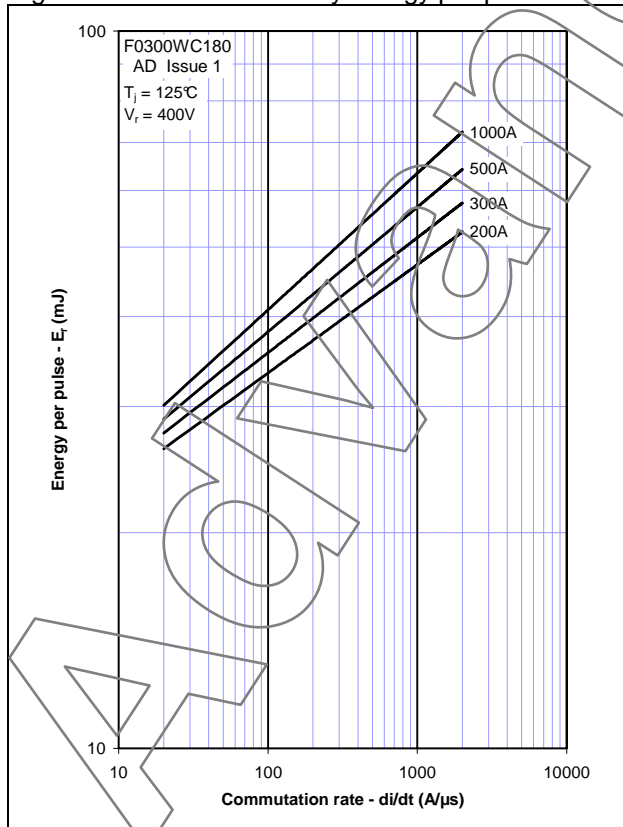


Figure 8 - Sine wave energy per pulse

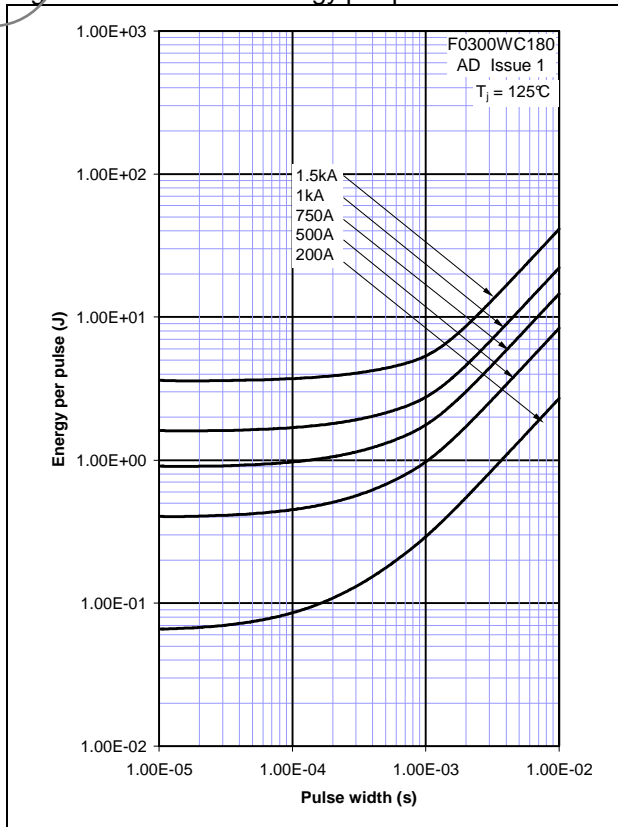


Figure 9 - Sine wave frequency vs. pulse width

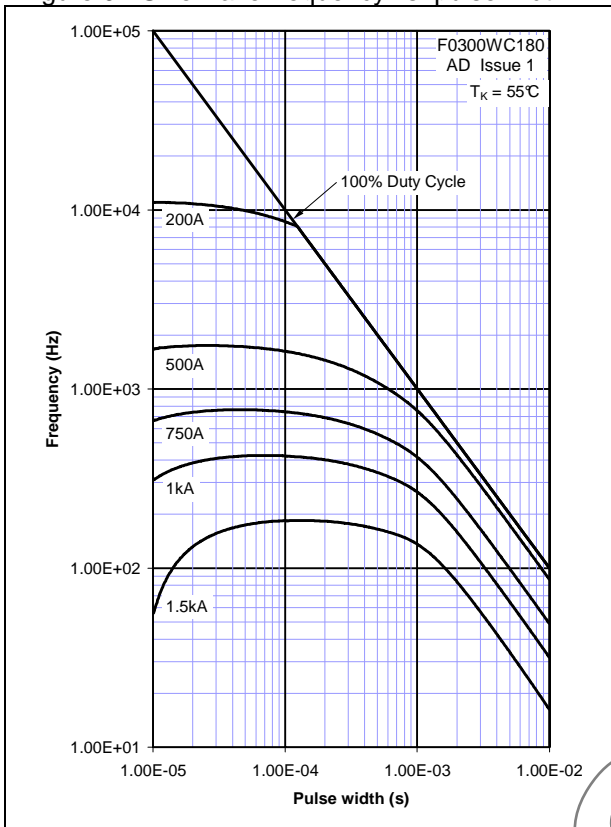


Figure 10 - Sine wave frequency vs. pulse width

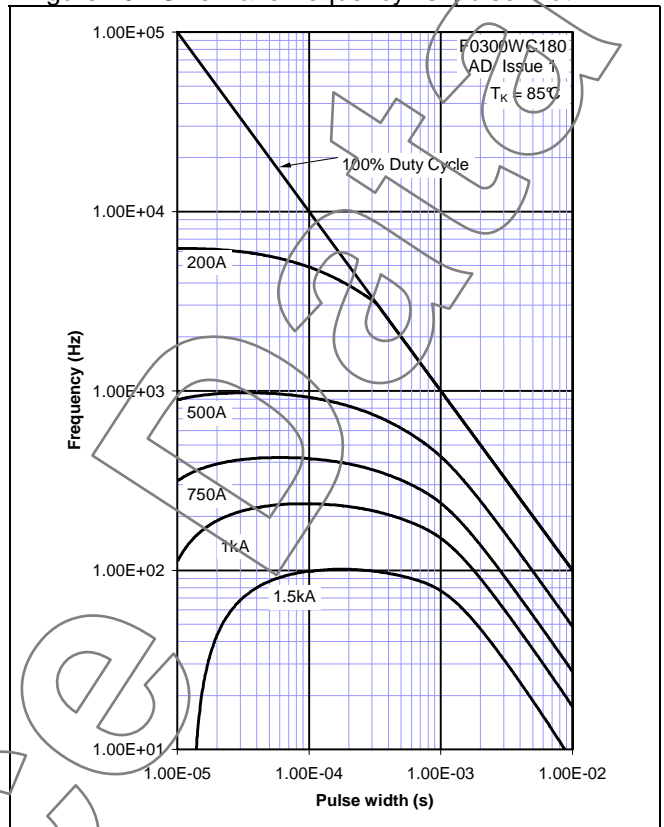


Figure 11 - Square wave energy per pulse

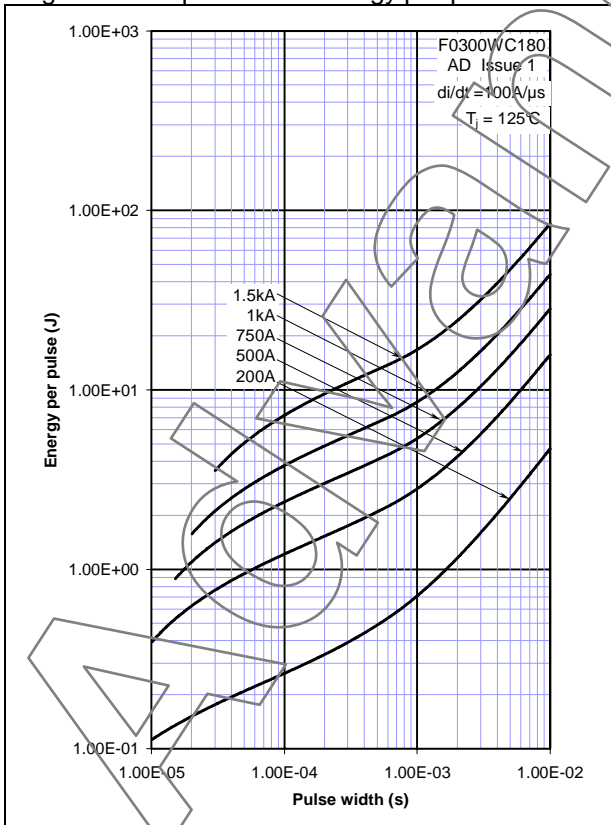


Figure 12 - Square wave energy per pulse

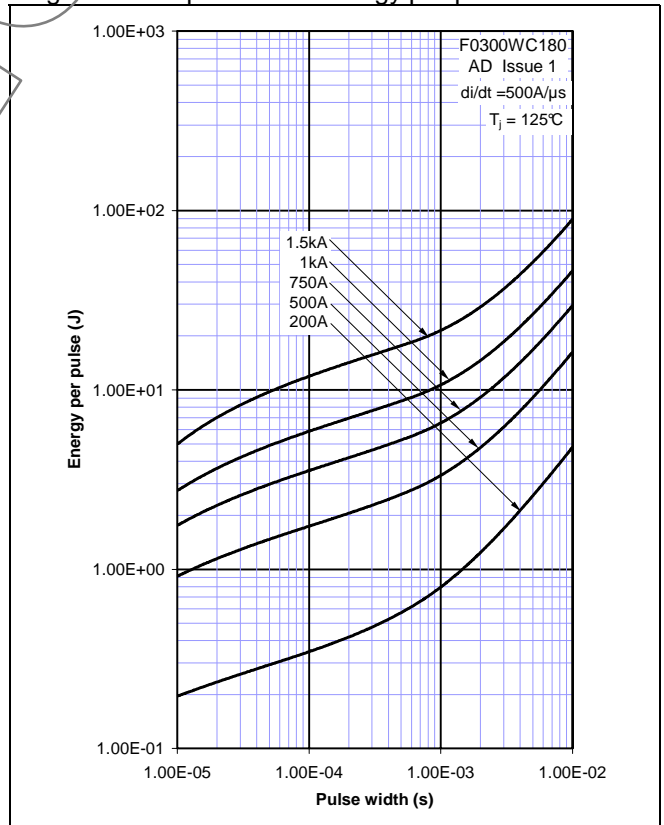


Figure 13 - Square wave frequency vs. pulse width

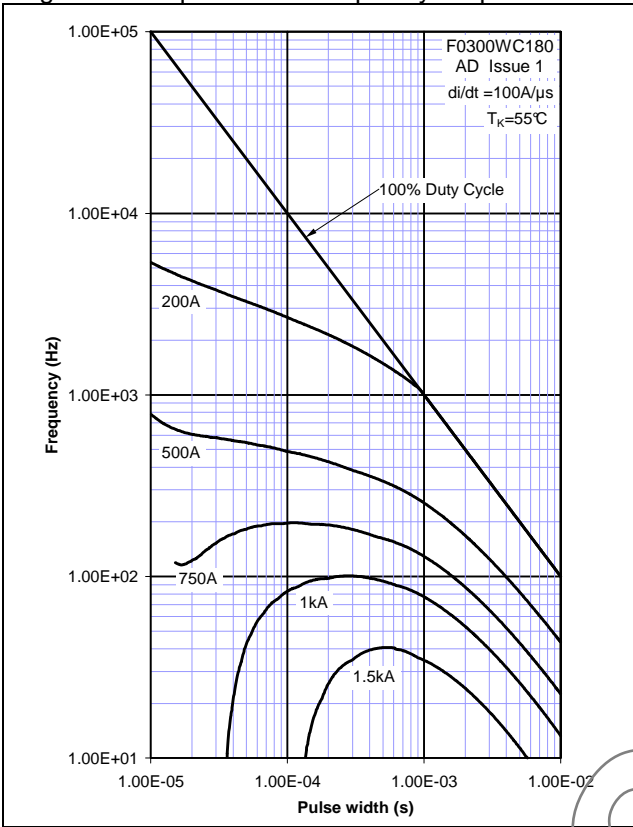


Figure 14 - Square wave frequency vs. pulse width

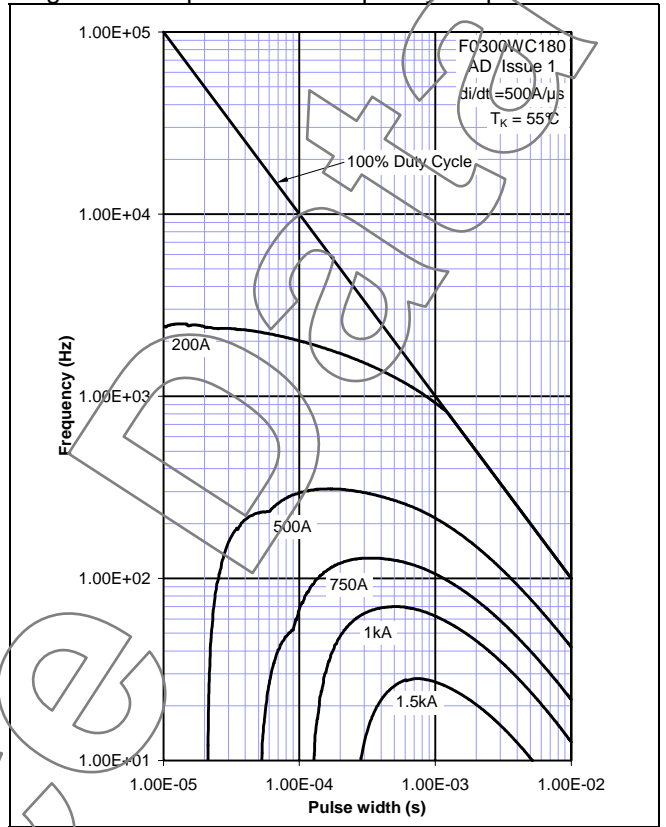


Figure 15 - Square wave frequency vs. pulse width

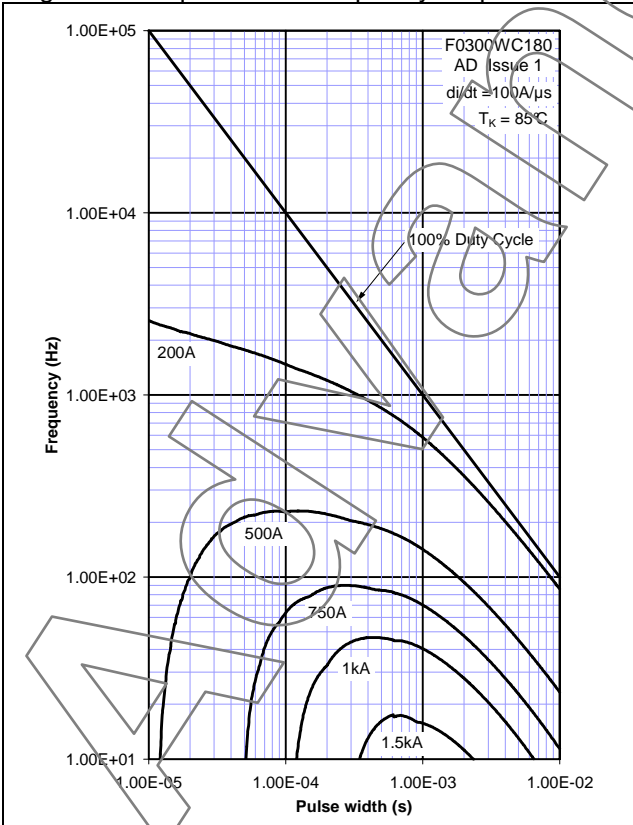


Figure 16 - Square wave frequency vs. pulse width

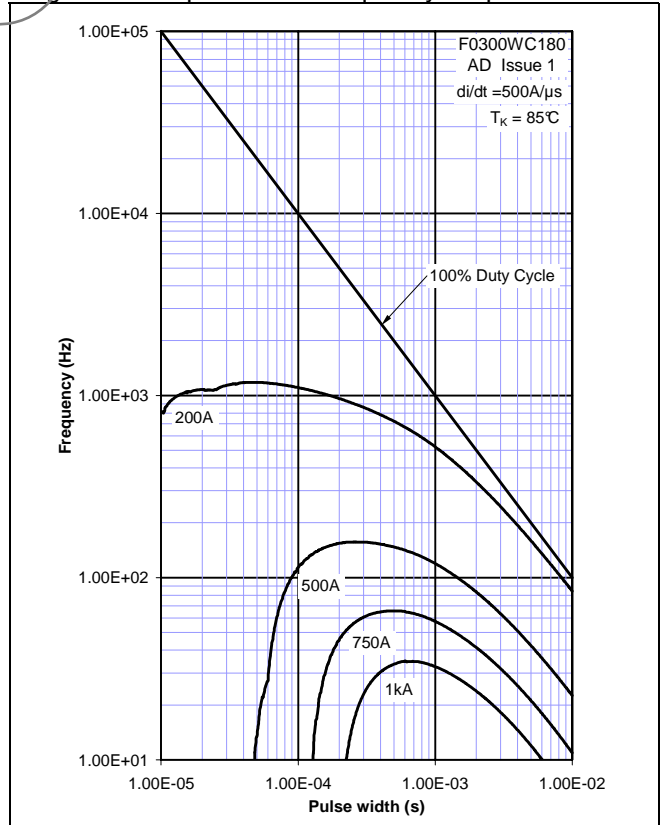


Figure 17 – Safe operating area

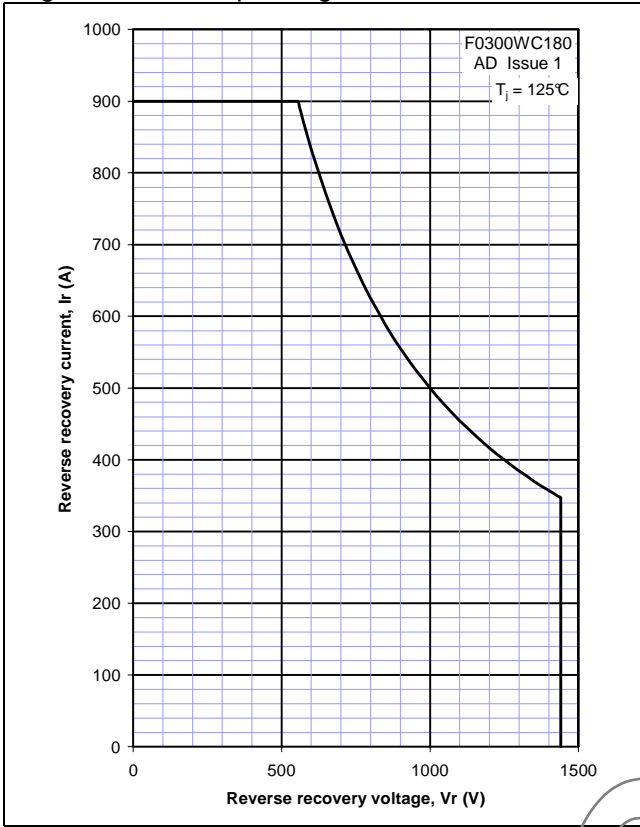


Figure 18 – Transient thermal impedance

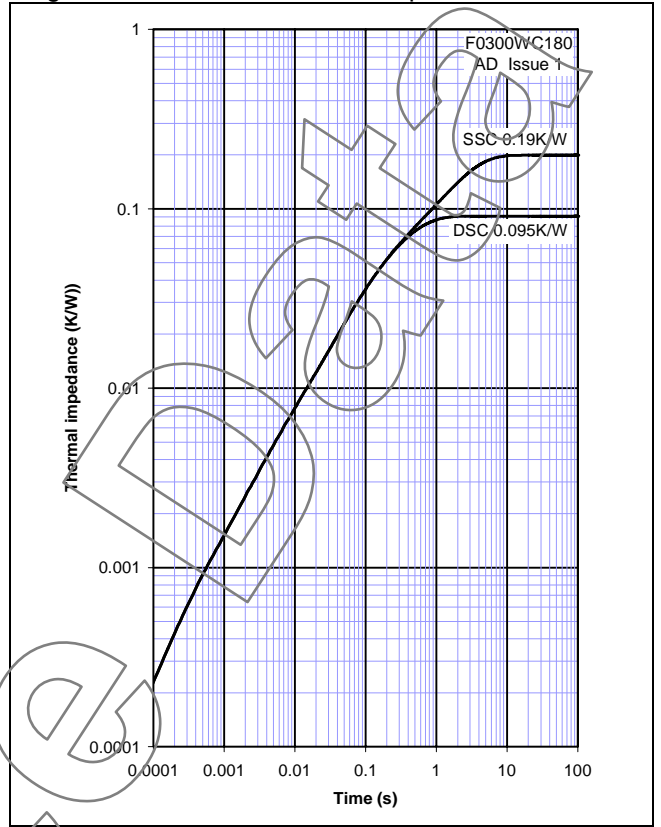
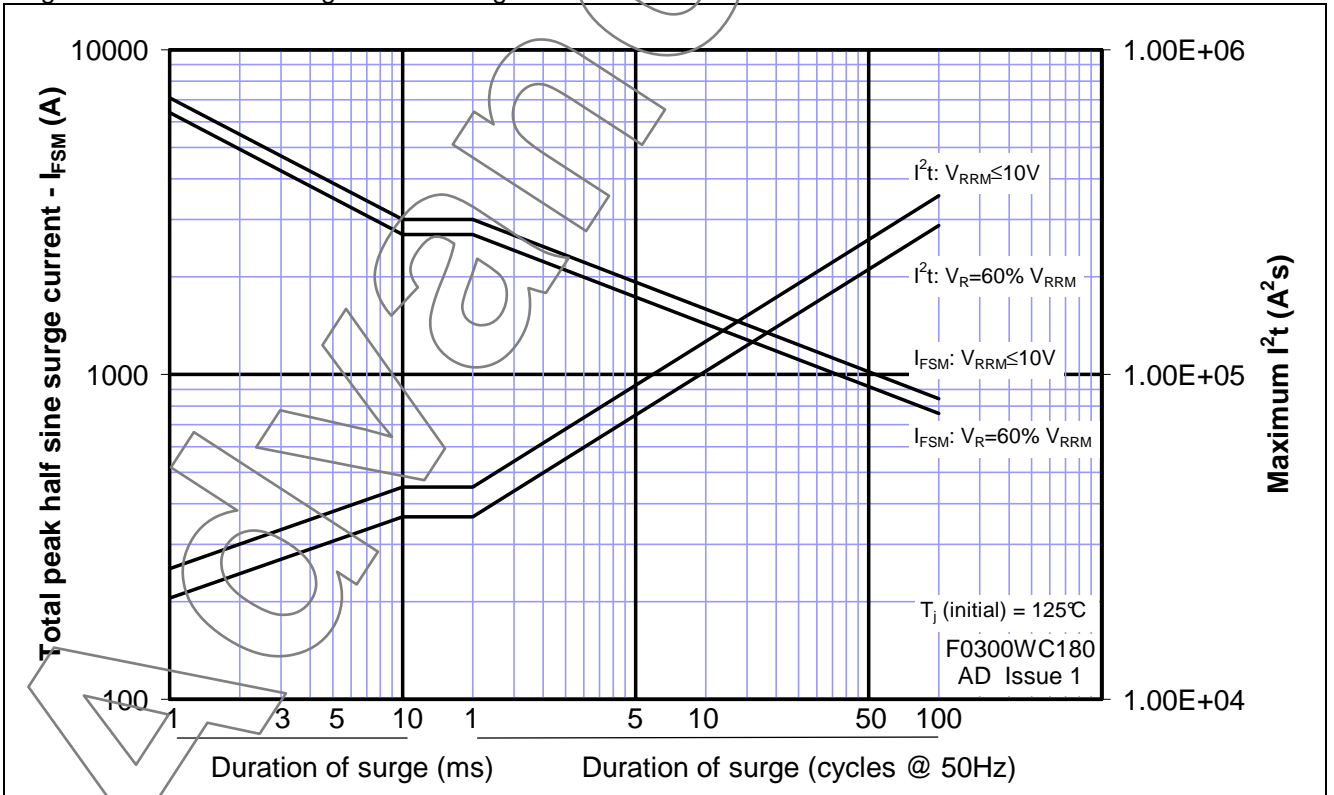
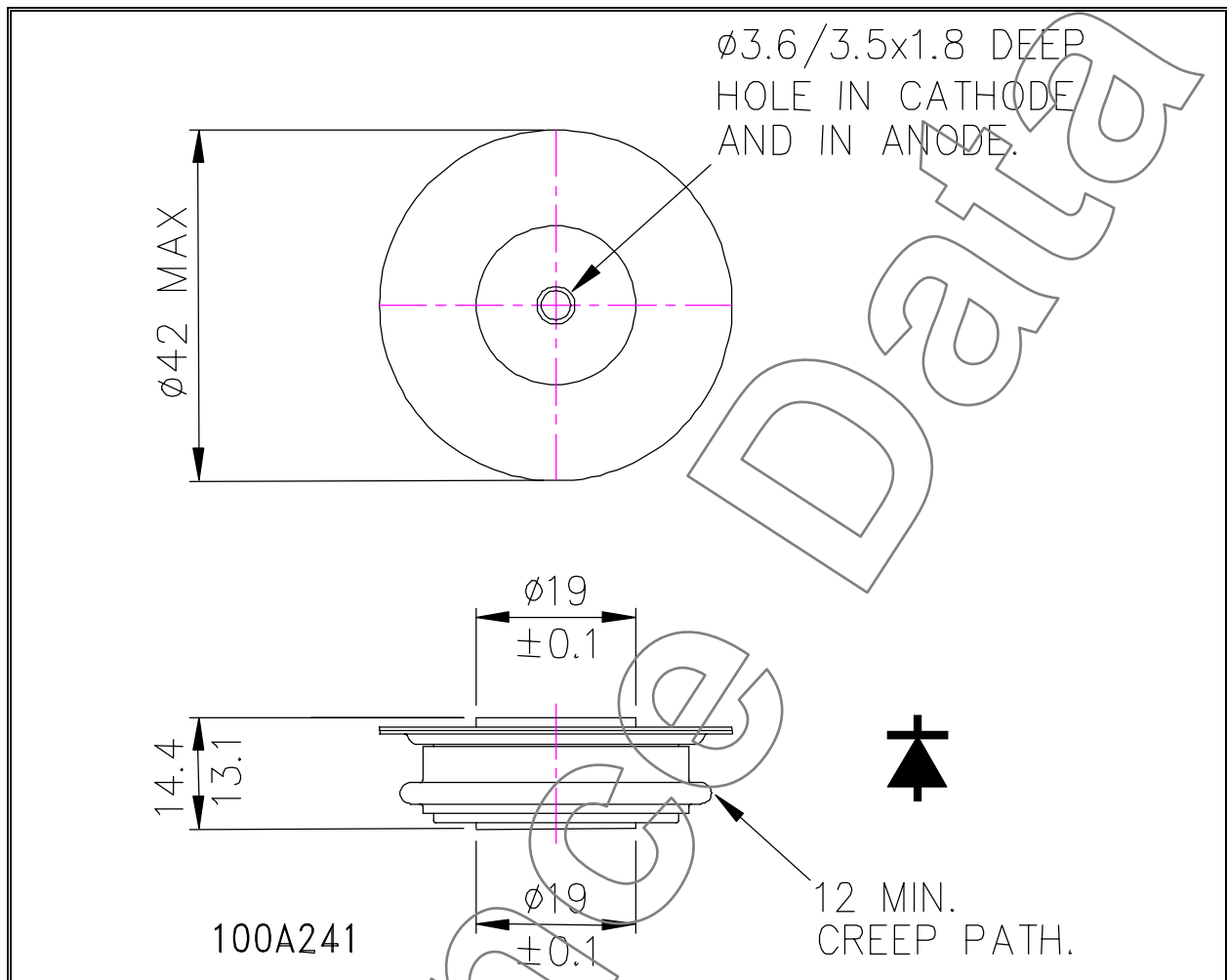


Figure 19 – Maximum surge and I^2t ratings



Outline Drawing & Ordering Information



ORDERING INFORMATION				
(Please quote 10 digit code as below)				
F	0300	WC	◆◆	0
Fixed Type Code	Fixed Type Code	Fixed outline code	Voltage code 18	Fixed code

Order code: F0300WC180 – 1800V V_{RRM} , 14.4mm clamp height capsule.

IXYS Semiconductor GmbH
 Edisonstraße 15
 D-68623 Lampertheim
 Tel: +49 6206 503-0
 Fax: +49 6206 503-627
 E-mail: marcom@ixys.de

An IXYS Company

www.westcode.com

www.ixys.com

Westcode Semiconductors Ltd
 Langley Park Way, Langley Park,
 Chippenham, Wiltshire SN15 1GE.
 Tel: +44 (0)1249 444524
 Fax: +44 (0)1249 659448
 E-mail: WSL.sales@westcode.com

Westcode Semiconductors Inc
 3270 Cherry Avenue
 Long Beach CA 90807 USA
 Tel: +1 (562) 595 6971
 Fax: +1 (562) 595 8182
 E-mail: WSI.sales@westcode.com

The information contained herein is confidential and is protected by Copyright. The information may not be used or disclosed except with the written permission of and in the manner permitted by the proprietors Westcode Semiconductors Ltd. © Westcode Semiconductors Ltd.

In the interest of product improvement, Westcode reserves the right to change specifications at any time without prior notice.

Devices with a suffix code (2-letter, 3-letter or letter/digit/letter combination) added to their generic code are not necessarily subject to the conditions and limits contained in this report.